

# **Notice of References Cited**

Application/Control No.  
09/883,036

Applicant(s)/Patent Under  
Reexamination  
MA ET AL.

Examiner  
Karen B Addison

Art Unit  
2834

Page 1 of 1

## **U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-6,236,281	05-2001	Nguyen et al.	333/186
*	B	US-5,537,083	07-1996	Lin et al.	333/186
*	C	US-5,455,547	10-1995	Lin et al.	333/186
*	D	US-5,025,346	06-1991	Tang et al.	361/283.1
*	E	US-5,491,604	02-1996	Nguyen et al.	333/197
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

## **FOREIGN PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

## **NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)			
*	U	Hsu "Mechanically Temperature-Compensated Flexural-Mode Micro- mechanical Resonator" IEEE (Dec 12, 2000) Pages (399-402).			
	V				
	W				
	X				

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.